

## **Ordering Information**

Part Number	Ambient Temperature Range	Package	Environmental		
AOZ8811DI-05	-40°C to +85°C	DFN 1.0 x 0.6	RoHS Compliant Green Product		



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant. Please visit www.aosmd.com/media/AOSGreenPolicy.pdf for additional information.

## **Absolute Maximum Ratings**

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
VP – VN	5V
Peak Pulse Current (I <sub>PP</sub> ), t <sub>P</sub> = 8/20μs	2A
Storage Temperature (T <sub>S</sub> )	-65°C to +150°C
ESD Rating per IEC61000-4-2, Contact <sup>(1)</sup>	±15kV
ESD Rating per IEC61000-4-2, Air <sup>(1)</sup>	±15kV
ESD Rating per Human Body Model <sup>(2)</sup>	±15kV

#### Notes

- 1. IEC 61000-4-2 discharge with C  $_{Discharge}$  = 150pF,  $R_{Discharge}$  = 330 $\Omega.$
- 2. Human Body Discharge per MIL-STD-883, Method 3015  $C_{Discharge}$  = 100pF,  $R_{Discharge}$  = 1.5k $\Omega$ .

## **Maximum Operating Ratings**

Parameter	Rating
Junction Temperature (T <sub>J</sub> )	-40°C to +125°C

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## **Electrical Characteristics**

T<sub>A</sub> = 25°C unless otherwise specified.

Symbol	Parameter	Diagram
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current	
V <sub>CL</sub>	Clamping Voltage @ I <sub>PP</sub>	
V <sub>RWM</sub>	Working Peak Reverse Voltage	F
I <sub>R</sub>	Maximum Reverse Leakage Current	<b> </b>
V <sub>BR</sub>	Breakdown Voltage	<b>/</b>
I <sub>T</sub>	Test Current	VCLVBR VRWM V V
I <sub>F</sub>	Forward Current	IR V <sub>F</sub>
V <sub>F</sub>	Forward Voltage	
P <sub>PK</sub>	Peak Power Dissipation	I <sub>PP</sub>
CJ	Capacitance @ V <sub>R</sub> = 0 and f = 1MHz	-

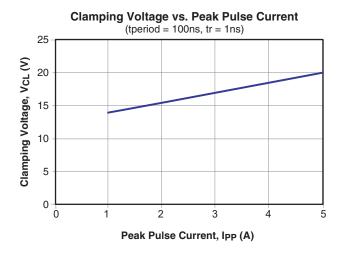
## **Electrical Characteristics**

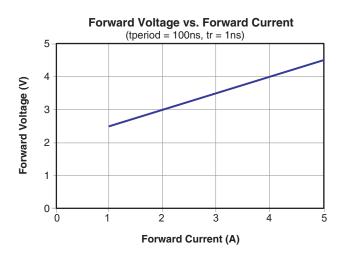
 $T_A$  = 25°C unless otherwise noted,  $V_F$  = 0.95V Max. @  $I_F$  = 15mA for all types

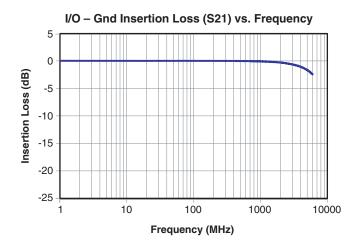
	Device	V <sub>RWM</sub> (V)	V <sub>PP</sub> (V)	Ι <sub>R</sub> (μΑ)	V <sub>F</sub> (V)	V <sub>CL</sub> Max.			V <sub>CL</sub> Max.	
Device	Marking	Max.	Max.	Max.	Typ.	I <sub>PP</sub> = 1A   I <sub>PP</sub> = 2A   I <sub>PP</sub> = 5		I <sub>PP</sub> = 5A	Typ.	Max.
AOZ8811DI-05	С	5.0	6.0	1.0	0.75	14.00	15.50	20.00	0.65	0.75

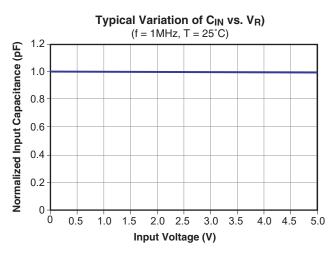


# **Typical Performance Characteristics**



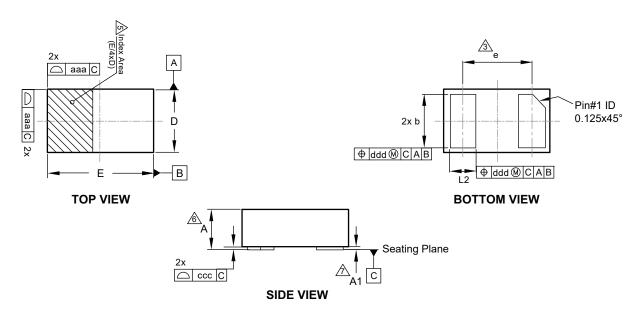




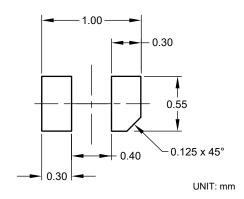




## Package Dimensions, DFN 1.0 x 0.6



#### RECOMMENDED LAND PATTERN



#### **Dimensions in millimeters**

Symbols	Min.	Nom.	Max.					
Α	0.47	0.51	0.55					
A1	0.00	0.02	0.05					
b	0.45	0.50	0.55					
D	0.60 BSC							
E	1.00 BSC							
е	(	).65 BSC	)					
L	0.20 0.25 0.30							
aaa	0.05							
ccc	0.03							
ddd	0.10							

#### **Dimensions in inches**

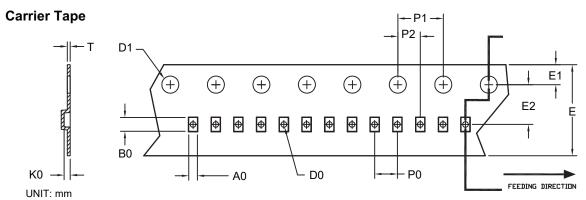
Symbols	Min.	Nom.	Max.
Α	0.019	0.020	0.022
A1	0.000	0.001	0.002
b	0.018	0.020	0.022
D		0.024	
E		0.039	
е		0.026	
L	0.008	0.010	0.012
aaa		0.002	
CCC		0.001	
ddd		0.004	

#### Notes:

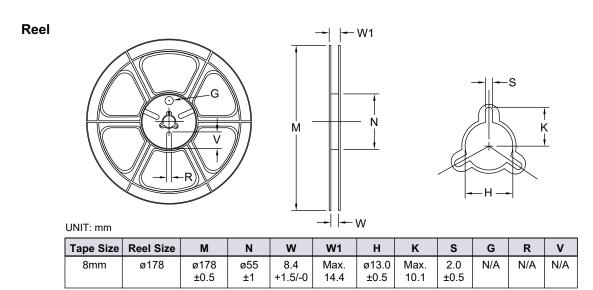
- 1. Dimensions and tolerancing conform to ASME Y14.5-2009.
- 2. All dimensions are in milliteters.
- <u>\$\dagger\$</u> "e" represents the terminal grid pitch.
- 4. N is the total number of terminals.
- ⚠ A visual index feature must be located within the hatched area. Typical index feature (chamfer) must be located on the edge of the Pin#1 feature.
- This dimension includes stand-off height "A1" and packaged body thickness, but does not include attached feature e.g. external heatsink or chip capacitors, an internal heatslug is not considered as attached feature.
- ⚠ Dimension "A1" is primarily terminal plating, and does not include small metal protrusions.

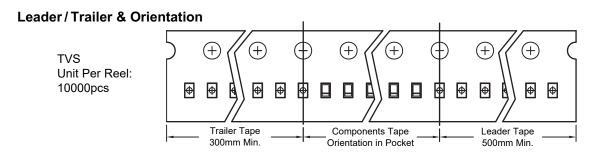


## Tape and Reel Dimensions, DFN 1.0 x 0.6



Option	Package	A0	В0	K0	D0	D1	E	E1	E2	P0	P1	P2	Т
А	DFN 1.0x0.6/ DFN 1.0x0.6A (8 mm)	0.69 ±0.05	1.19 ±0.05	0.66 ±0.05	0.40 ±0.05	1.50 ±0.10	8.00 +0.3/-0.1	1.75 ±0.10	3.50 ±0.05	2.00 ±0.05	4.00 ±0.10	2.00 ±0.05	0.23 ±0.02
В	DFN 1.0x0.6/ DFN 1.0x0.6A (8 mm)	0.65 ±0.04	1.05 ±0.04	0.61 ±0.04	0.40 ±0.05	1.50 ±0.10	8.00 +0.3/-0.1	1.75 ±0.10	3.50 ±0.05	2.00 ±0.10	4.00 ±0.10	2.00 ±0.05	0.20 ±0.05

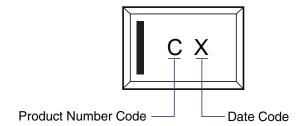




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### **Part Marking**



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As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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